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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): W. J. Cote, et al

Docket No.: BU9-98-100

Serial No.:

Group No. 2818

Date Filed: Herewith

Date: May 5, 1999

FOR: Chemical-Mechanical Planarization of Barriers or Liners for Copper Metallurgy

Assistant Commissioner for Patents  
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT PURSUANT TO  
37 C.F.R §§1.97(b)

Sir:

In accordance with the duty of disclosure under 37 C.F.R §1.56 and pursuant to 37 C.F.R. §1.97(b), Applicant(s) hereby notifies the U.S. Patent and Trademark Office of the documents listed on the attached Form PTO-1449.

Respectfully Submitted,  
For: W. J. Cote et al

By

  
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Patent Copies